

MS60P03

P-Channel 60-V (D-S) MOSFET

Description

The MS60P03 is the highest performance P-ch MOSFETs with super high dense cell design for low $R_{DS(ON)}$ and gate charge for high efficiency fast switching applications.

The device meets the RoHS and Green Product requirement with full function reliability approved.

Features

- Low Reverse Transfer Capacitance
- High Switching Speed
- Improved dv/dt Capability
- Low Gate Charge
- Green Device Available

Typical Applications

- Motor Control
- Net Working
- LED Applications

Package type : SOT-23

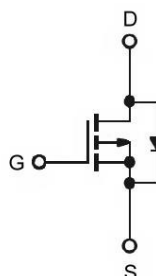
Packing & Order Information

3,000/Reel

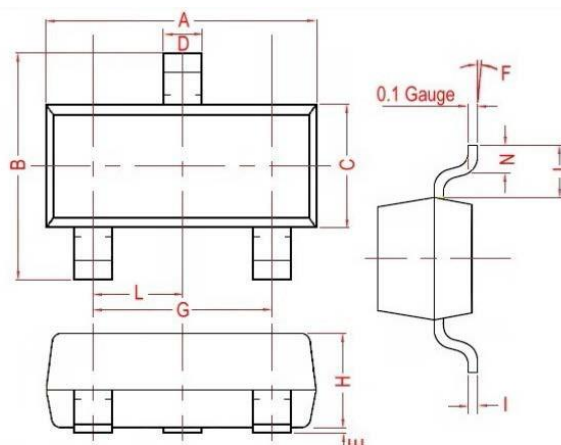


RoHS Compliant

Graphic Symbol

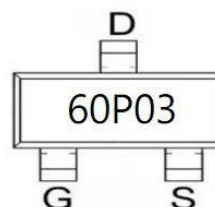


Package Dimension



REF.	Millimeter		REF.	Millimeter	
	Min.	Max.		Min.	Max.
A	2.70	3.10	G	1.90 Ref.	
B	2.30	3.00	H	0.90	1.30
C	1.20	1.75	I	0.05	0.21
D	0.30	0.50	J	0.58 Ref.	
E	0.01	0.15	L	0.95 Typ.	
F	0°	10°	N	0.20 Min.	

Marking



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MAXIMUM RATINGS AND ELECTRICAL CHARACTERISTICS

Absolute Maximum Ratings (unless otherwise specified)

Symbol	Parameter	Value	Units
V _{DS}	Drain-Source Voltage	-60	V
V _{GS}	Gate-Source Voltage	±20	V
I _D	Continuous Drain Current ¹ (T _A =25°C)	-3	A
	Continuous Drain Current ¹ (T _A =70°C)	-2.3	A
I _{DM}	Pulsed Drain Current ^{1,2} (T _A =25°C)	-12	A
P _D	Power Dissipation ³ (T _A =25°C)	2	W
T _J /T _{STG}	Operating Junction and Storage Temperature	-55 to +150	°C

Thermal Resistance Ratings

Symbol	Parameter	Maximum	Units
R _{θJA}	Maximum Junction-to-Ambient ¹	125	°C/W
R _{θJC}	Maximum Junction-to-Case ¹	80	°C/W

Electrical Characteristics(T_J=25°C unless otherwise specified)

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Units
V _{GS(th)}	Gate Threshold Voltage	V _{DS} =V _{GS} , I _D =-250μA	-1.0	-	-2.5	V
BV _{DSS}	Drain-Source Breakdown Voltage	V _{GS} =0V, I _D =-250μA	-60	-	-	V
I _{GSS}	Gate-Source Leakage Current	V _{DS} =0V, V _{GS} =±20V	-	-	±100	nA
I _{DSS}	Drain-Source Leakage Current	V _{DS} =-48V, V _{GS} =0V, T _J =25°C	-	-	-1	μA
		V _{DS} =-48V, V _{GS} =0V, T _J =125°C	-	-	-5	μA
R _{DS(on)}	Static Drain-Source On-Resistance ²	V _{GS} =-10V, I _D =-2A	-	120	140	mΩ
		V _{GS} =-4.5V, I _D =-1.5A	-	150	200	mΩ
V _{SD}	Diode Forward Voltage ²	I _S =-1.0A, V _{GS} =0V, T _J =25°C	-	-	-1.2	V
I _S	Continuous Source Current ^{1,4} (Diode)	V _G =V _D =0V, Force Current	-	-	-3.2	A

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Dynamic and switching Characteristics

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Units
Q _g	Total Gate Charge ²	V _{DS} = -20V	--	5.9	--	nC
Q _{gs}	Gate-Source Charge	I _D = -2A	--	2.9	--	
Q _{gd}	Gate-Drain Charge	V _{GS} = -4.5V	--	1.8	--	
t _{d(on)}	Turn-On Delay Time ²	V _{DD} = -12V	--	10	--	ns
t _r	Rise Time	I _D = -1A	--	17	--	
t _{d(off)}	Turn-Off Delay Time	V _{GS} = -10V	--	22	--	
t _f	Fall Time	R _G = 3.3Ω	--	21	--	
C _{iss}	Input Capacitance	V _{DS} = -15V	--	715	--	pF
C _{oss}	Output Capacitance	V _{GS} = 0V	--	51	--	
C _{rss}	Reverse Transfer Capacitance	f = 1.0MHz	--	34	--	

Notes

1. Surface mounted on a 1 inch² FR-4 board with 2OZ copper.
2. The data tested by pulsed, pulse width ≤ 300us, duty cycle ≤ 2%.
3. The power dissipation is limited by 150°C junction temperature.
4. The data is theoretically the same as I_D and I_{DM}, in real applications, should be limited by total power dissipation.

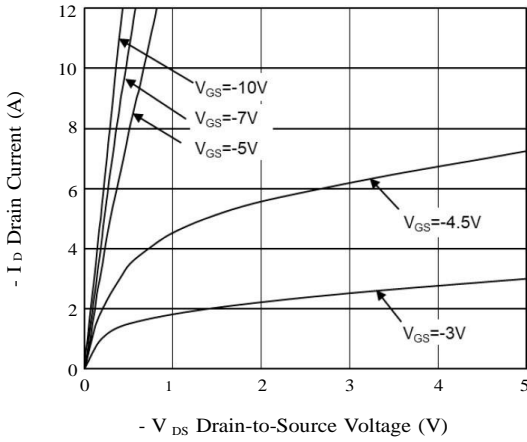


FIG.1-Typical Output Characteristics

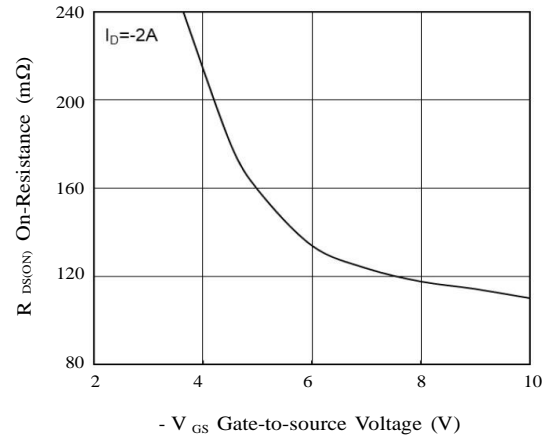


FIG.2-On-Resistance vs. G-S Voltage

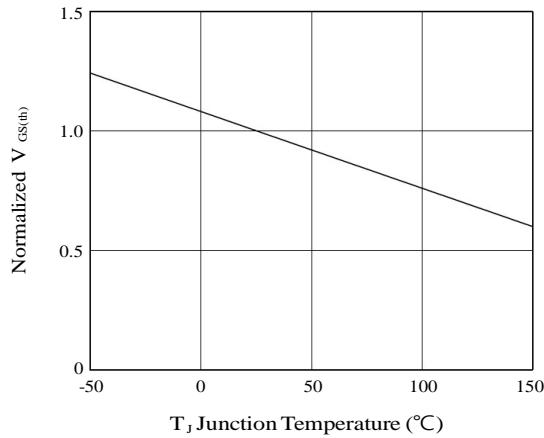


FIG.3-Normalized $V_{GS(th)}$ vs. T_J

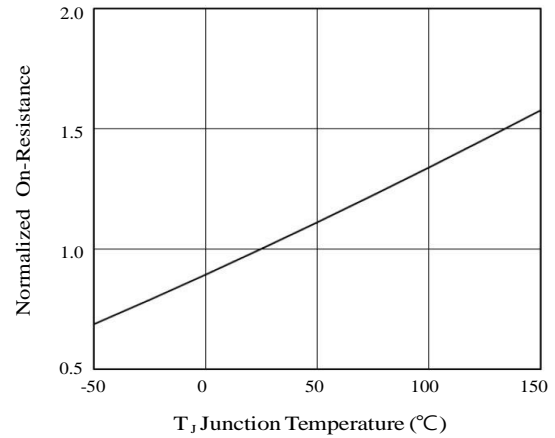


FIG.4-Normalized $R_{DS(ON)}$ vs. T_J

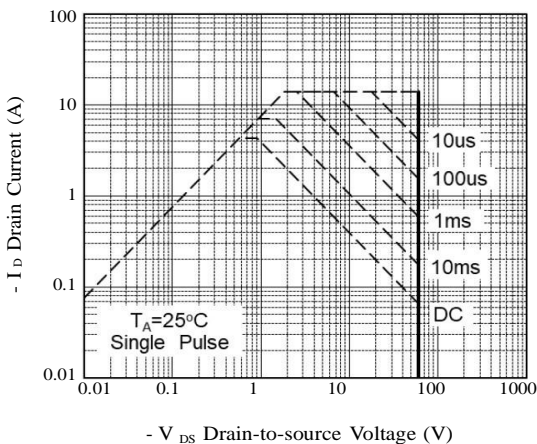


FIG.5-Safe Operating Area

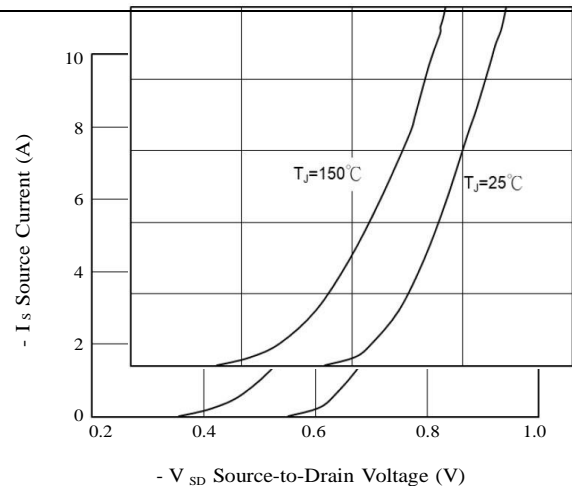


FIG.6-Source Drain Forward Characteristics

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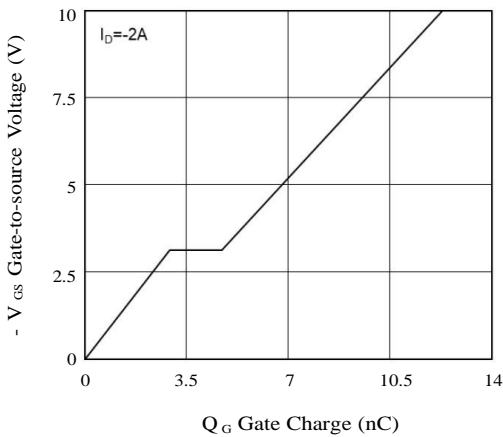


FIG.7-Gate Charge Characteristics

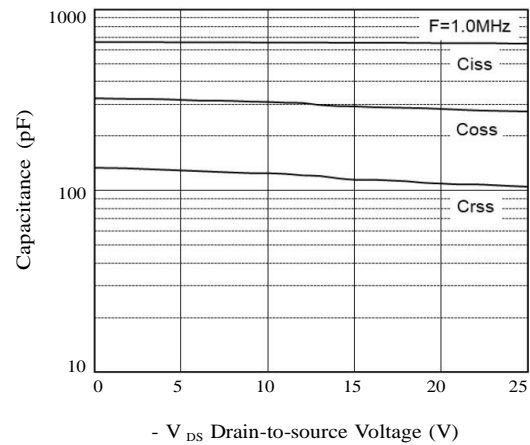


FIG.8-Capacitance Characteristics

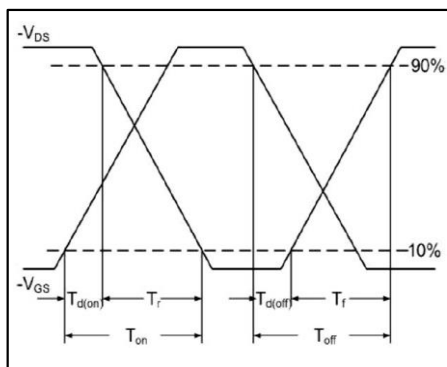


FIG.9-Switching Time Waveform

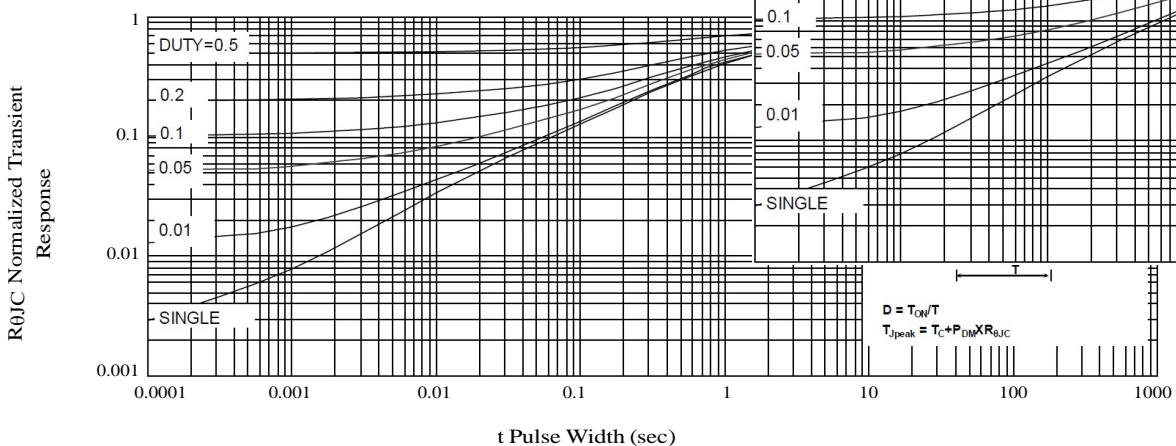
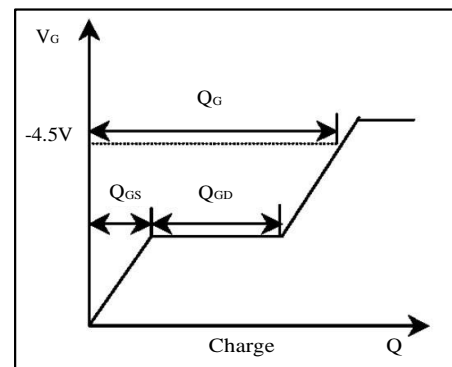


FIG.11-Normalized Maximum Transient Thermal Impedance

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